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74LVC374A

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

Rev. 3 — 6 December 2012

Product data sheet

1. General description

The 74LVC374A is an octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications. A clock input (CP) and an outputs enable input (OE) are common to all flip-flops.

The eight flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition.

When pin \overline{OE} is LOW, the contents of the eight flip-flops is available at the outputs. When pin \overline{OE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of the \overline{OE} input does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

The 74LVC374A is functionally identical to the 74LVC574A, but has a different pin arrangement.

2. Features and benefits

- 5 V tolerant inputs/outputs; for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- 8-bit positive edge-triggered register
- Independent register and 3-state buffer operation
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - ◆ MM JESD22-A115-B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from −40 °C to +85 °C and −40 °C to +125 °C



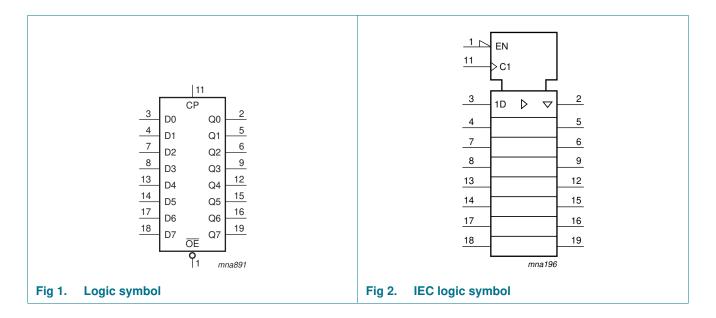
Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

3. Ordering information

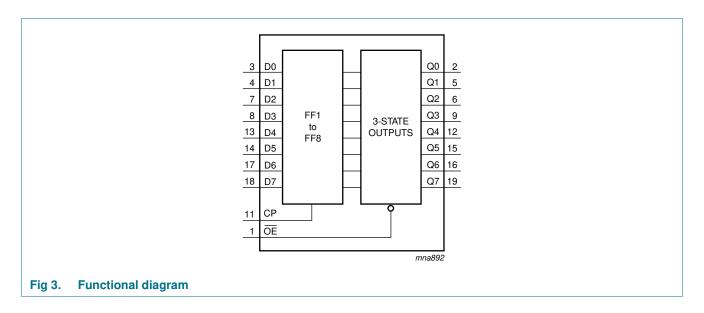
Table 1. Ordering information

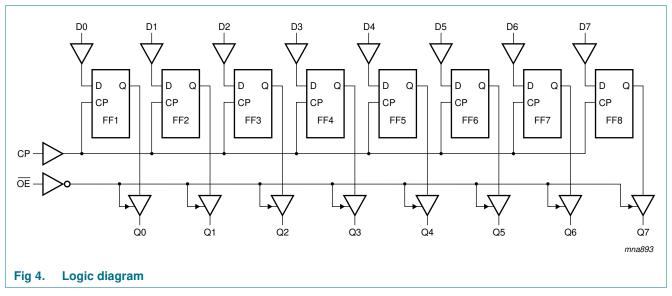
Type number	Package			
	Temperature range	Name	Description	Version
74LVC374AD	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74LVC374ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74LVC374APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74LVC374ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 \times 4.5 \times 0.85 mm	SOT764-1

4. Functional diagram



Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

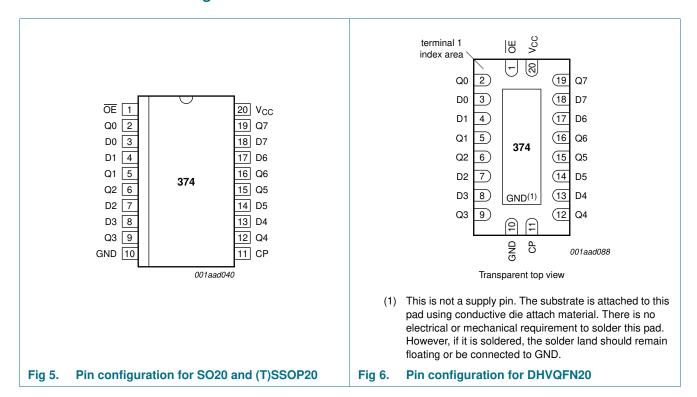




Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1	ŌĒ	output enable input (active LOW)
Q[0:7]	2, 5, 6, 9, 12, 15, 16, 19	3-state flip-flop output
D[0:7]	3, 4, 7, 8, 13, 14, 17, 18	data input
10	GND	ground (0 V)
11	CP	clock input (LOW-to-HIGH, edge-triggered)
20	V_{CC}	supply voltage

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

6. Functional description

Table 3. Function table[1]

Operating mode	Input		Internal flip-flop	Output	
	OE	СР	Dn		Qn
Load and read register	L	\uparrow	I	L	L
	L	↑	h	Н	Н
Load register and disable	Н	↑	I	L	Z
outputs	Н	↑	h	Н	Z

^[1] H = HIGH voltage level

 $h = HIGH \ voltage \ level \ one \ set-up \ time \ prior \ to \ the \ LOW-to-HIGH \ CP \ transition$

L = LOW voltage level

I = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition

Z = high-impedance OFF-state

↑ = LOW-to-HIGH clock transition

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA
V _I	input voltage		[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V		-	±50	mA
V _O	output voltage	output HIGH or LOW state	[2]	-0.5	$V_{CC} + 0.5$	V
		output 3-state	[2]	-0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			- 65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[3]	-	500	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO20 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For SSOP20 and TSSOP20 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
V _O	output voltage	output HIGH or LOW state	0	-	V_{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V _{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		V _{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.65 × V _{CC}	-	-	$0.65 \times V_{CC}$	-	٧
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
input	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$\begin{array}{c} 0.35 \times \\ V_{CC} \end{array}$	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
	HIGH-level	$V_{I} = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	$V_{CC} - 0.$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V_{OL}	LOW-level	$V_{I} = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \ \mu A; V_{CC} = 1.65 \ V \ to \ 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	8.0	V

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

 Table 6.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	0 °C to +8	5 °C	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
l _l	input leakage current	$V_{CC} = 3.6 \text{ V}; V_{I} = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 3.6$ V; $V_O = 5.5$ V or GND;	-	±0.1	±5	-	±20	μА
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	-	±0.1	±10	-	±20	μА
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	10	-	40	μΑ
Δl _{CC}	additional supply current	per input pin; V_{CC} = 2.7 V to 3.6 V; V_I = V_{CC} - 0.6 V; I_O = 0 A	-	5	500	-	5000	μА
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_I = \text{GND to } V_{CC}$	-	4.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

 Table 7.
 Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		-40 °C to +85 °C			-40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation	CP to Qn; see Figure 7	[2]						
	delay	V _{CC} = 1.2 V		-	16	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.2	7.4	16.3	2.2	18.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	3.9	8.4	1.5	9.7	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.5	8.0	1.5	10.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.3	7.0	1.5	9.0	ns
t _{en} en	enable time	OE to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	19	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.5	6.6	16.7	1.5	19.3	ns
		V _{CC} = 2.3 V to 2.7 V		1.5	3.7	9.3	1.5	10.8	ns
		V _{CC} = 2.7 V		1.5	3.8	8.5	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.0	7.5	1.5	9.5	ns
t _{dis}	disable time	OE to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	8.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.3	4.0	10.1	2.3	11.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.2	5.7	1.0	6.7	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.1	6.5	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	2.9	6.0	1.5	7.5	ns

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _W	pulse width	clock HIGH or LOW; see Figure 7	'						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		5.0	-	-	5.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		3.0	-	-	4.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		3.0	1.5	-	4.5	-	ns
t _{su}	set-up time	Dn to CP; see Figure 9							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		3.0	-	-	3.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		2.0	-	-	2.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.0	0	-	2.0	-	ns
t _h	hold time	Dn to CP; see Figure 9							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		3.0	-	-	3.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	-	-	1.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	0.6	-	1.5	-	ns
f _{max}	maximum	see Figure 7							
	frequency	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		100	-	-	64	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		125	-	-	100	-	MHz
		$V_{CC} = 2.7 \text{ V}$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		150	-	-	120	-	MHz
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C _{PD}	power	per flip-flop; $V_I = GND$ to V_{CC}	<u>[4]</u>						
	dissipation	V _{CC} = 1.65 V to 1.95 V		-	11.6	-	-	-	рF
	capacitance	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	13.6	-	-	-	pF
		V _{CC} = 3.0 V to 3.6 V		-	15.4	-	-	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volt

N = number of inputs switching

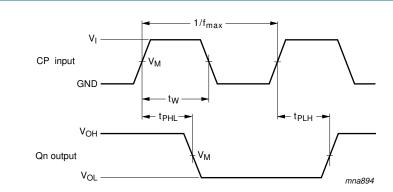
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} . t_{en} is the same as t_{PZL} and t_{PZH} .

^[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

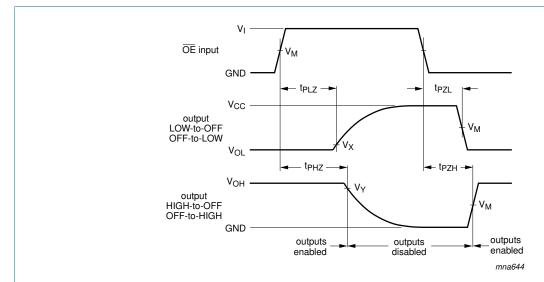
11. Waveforms



Measurement points are given in Table 8.

 $\ensuremath{V_{\text{OL}}}$ and $\ensuremath{V_{\text{OH}}}$ are typical output voltage levels that occur with the output load.

Fig 7. Clock (CP) to output (Qn) propagation delays, the clock pulse width, output transition times, and the maximum frequency



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 8. 3-state enable and disable times

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

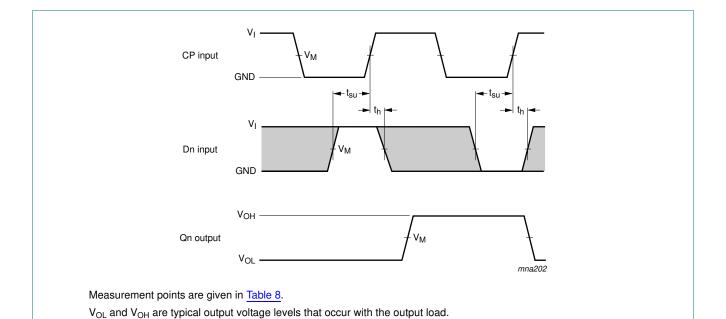


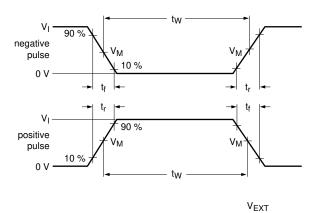
Fig 9. Data set-up and hold times for the Dn input to the CP input

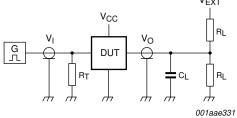
Table 8. Measurement points

Supply voltage	Input		Output		
V _{CC}	V _I	V _M	V _M	V _X	V _Y
1.2 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{\text{CC}}$	V _{OL} + 0.15 V	$V_{OH}-0.15~V$
1.65 V to 1.95 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V
2.3 V to 2.7 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V
2.7 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 V$	$V_{OH} - 0.3 V$
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 V$	$V_{OH} - 0.3 V$

The shaded areas indicate when the input is permitted to change for predicable output performance.

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state





Test data is given in Table 9.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 10. Load circuitry for switching times

Table 9. Test data

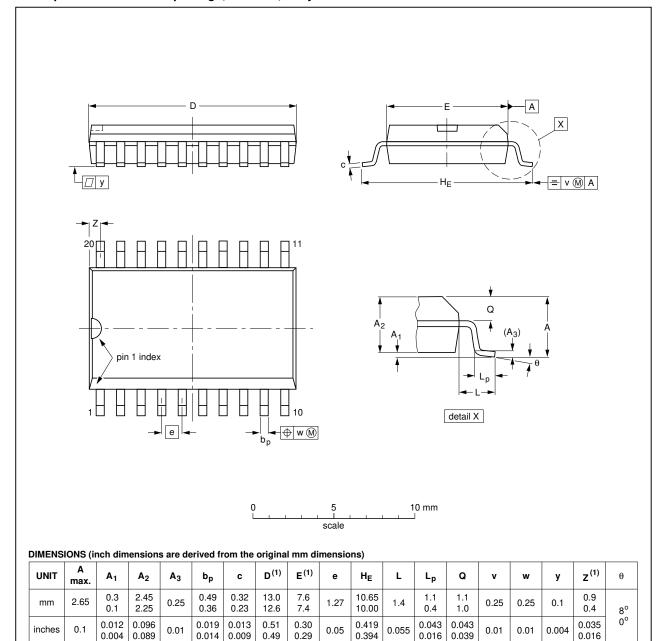
Supply voltage	Input		Load	Load		V _{EXT}		
V _{CC}	VI	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t_{PLZ} , t_{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND	

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013				99-12-27 03-02-19

Fig 11. Package outline SOT163-1 (SO20)

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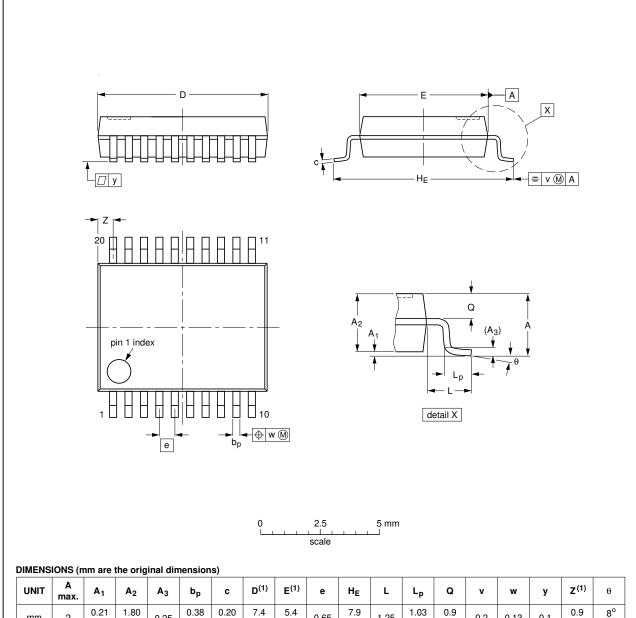
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74LVC374A **NXP Semiconductors**

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	e	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT339-1		MO-150				99-12-27 03-02-19	

Fig 12. Package outline SOT339-1 (SSOP20)

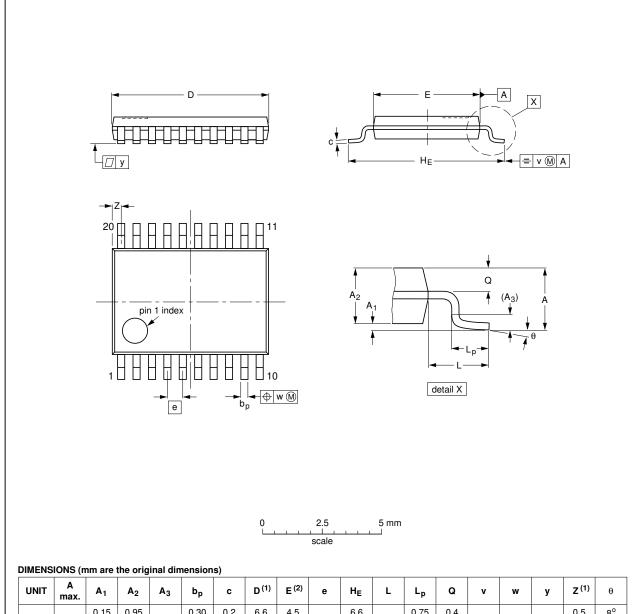
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74LVC374A **NXP Semiconductors**

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	e	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE				
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE		
SOT360-1		MO-153				-99-12-27 03-02-19		

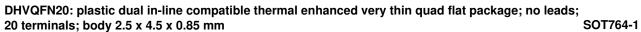
Fig 13. Package outline SOT360-1 (TSSOP20)

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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state



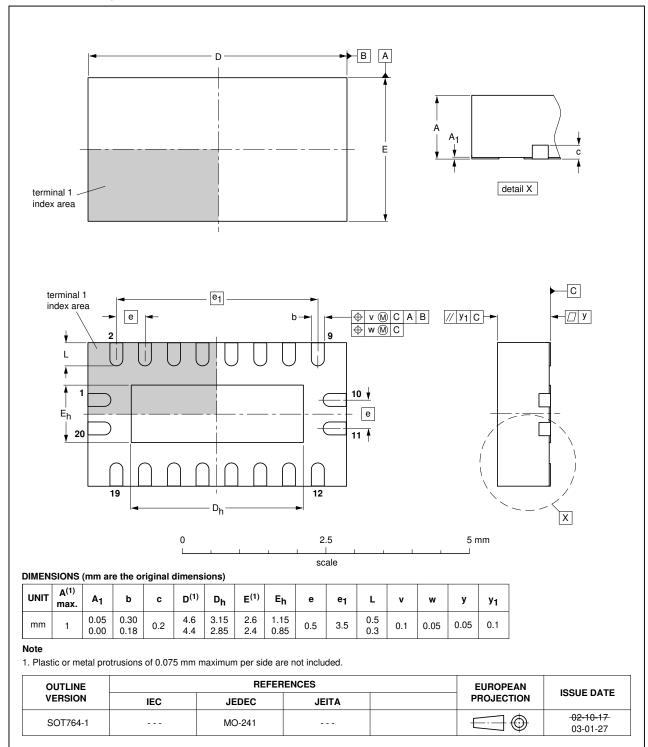


Fig 14. Package outline SOT764-1 (DHVQFN20)

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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
74LVC374A v.3	20121206	Product data sheet	-	74LVC374A v.2				
Modifications:	 The format of this of NXP Semicond 	data sheet has been redeuctors.	esigned to comply with the	e new identity guidelines				
	 Legal texts have been adapted to the new company name where appropriate. 							
	• <u>Table 4</u> , <u>Table 5</u> ,]	<u> Table 6, Table 7, Table 8</u> a	nd <u>Table 9</u> : values added	for lower voltage ranges.				
74LVC374A v.2	20030514	Product specification	-	74LVC374A v.1				
74LVC374A v.1	19980729	Product specification	-	-				

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

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